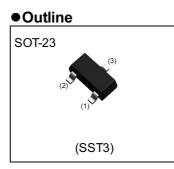
DTB123YC HZG

PNP -500mA -50V Digital transistor (with built-in resistors)

Datasheet

AEC-Q101 Qualified

Parameter	Value
V _{CC}	-50V
Ι _C	-500mA
R ₁	2.2kΩ
R ₂	10kΩ



Features

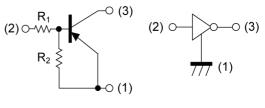
- 1)Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors.(see equivalent circuit)
- 2)The bias resistors consist of thin-film resistors with complete isolation to allow positive

biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.

3)Only the on/off conditions need to be set for operation, making the device desigh easy.

4) Complementary NPN Types: DTD123YC HZG

Inner circuit



(1) GND (+) (EMITTER)(2) IN (BASE)(3) OUT (COLLECTOR)

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTB123YC HZG	SOT-23 (SST3)	2924	T116	180	8	3000	F52

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter	Symbol	Values	Unit
Supply voltage	V _{CC}	-50	V
Input voltage	V _{IN}	-12 to 5	V
Collector current	I _C *1	-500	mA
Power dissipation	P _D *2	200	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

•Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Cump of	Conditions	Values			1.1	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Inputivoltogo	V _{I(off)}	V _{CC} = -5V, I _O = -100µA	-	-	-0.3	- v	
Input voltage	V _{I(on)}	V _O = -0.3V, I _O = -20mA	-2.0	-	-		
Output voltage	V _{O(on)}	$I_{\rm O} = -50 {\rm mA}, I_{\rm I} = -2.5 {\rm mA}$		-100	-300	mV	
Input current	I _I	V _I = -5V	-	-	-3.6	mA	
Output current	I _{O(off)}	V _{CC} = -50V, V _I = 0V	-	-	-500	nA	
DC current gain	Gı	V _O = -5V, I _O = -50mA	56	-	-	-	
Input resistance	R ₁	-	1.54	2.2	2.86	kΩ	
Resistance ratio	R_2/R_1	-	3.6	4.5	5.5	-	
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 50mA, f = 100MHz	-	200	-	MHz	

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference land.



 $V_{CC} = -5V$

•Electrical characteristic curves (T_a =25°C)

(ON Characteristics)

Fig.1 Input Voltage vs. Output Current

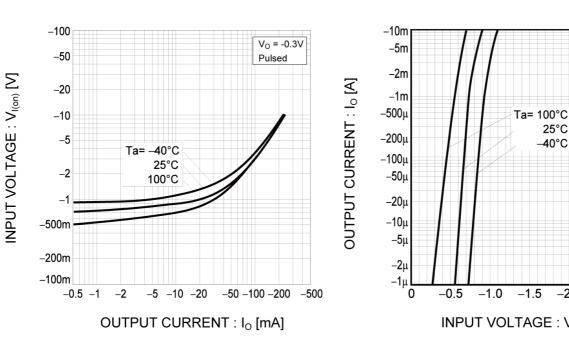


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

INPUT VOLTAGE : V_{I(off)} [V]

-2.0

-2.5

-3.0

Fig.3 Output Current vs. Output Voltage

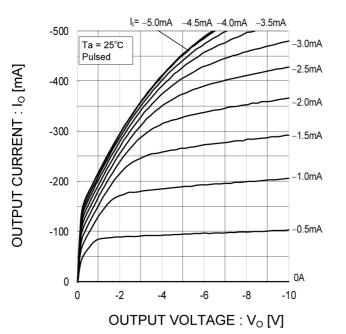
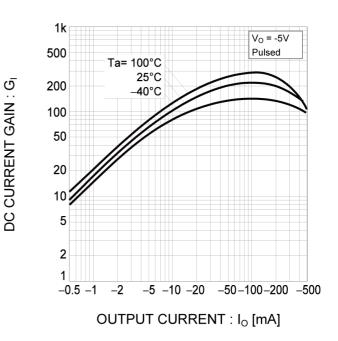


Fig.4 DC Current Gain vs. Output Current





•Electrical characteristic curves (T_a =25°C)

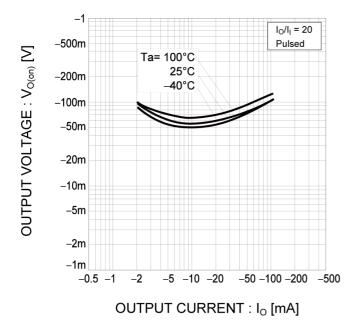
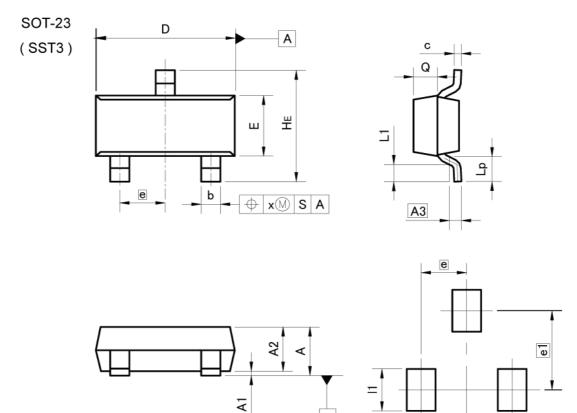


Fig.5 Output Voltage vs. Output Current



DTB123YC HZG

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

b2

DIM		ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	0.90	1.20	0.035	0.047
A1	0.00	0.10	0.000	0.004
A2	0.85	1.15	0.033	0.045
A3	0.1	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.70	3.10	0.106	0.122
E	1.20	1.50	0.047	0.059
е	0.	0.95		37
HE	2.20	2.60	0.087	0.102
L1	0.20	-	0.008	-
Lp	0.30	-	0.012	-
Q	0.40	0.60	0.016	0.024
х	-	0.10	-	0.004
			-	
	NATI INA	TEDO	INC	

S

DIM		INCHES		
DIW	MIN MAX		MIN	MAX
b2	-	0.60	-	0.024
e1	1.70		0.067	
1	-	0.90	-	0.035

Dimension in mm/inches



Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Ap	pplications
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JAPAN	USA	EU	CHINA
CLASSI	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASS III	CLASSⅢ	CLASSII

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
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 - [h] Use of the Products in places subject to dew condensation
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- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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